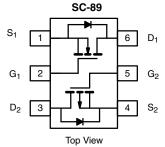




Complementary N- and P-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY						
	V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (mA)			
N-Channel	60	1.40 at V _{GS} = 10 V	500			
		3 at V _{GS} = 4.5 V	200			
P-Channel	- 60	4 at V _{GS} = - 10 V	- 500			
		8 at V _{GS} = - 4.5 V	- 25			



Ordering Information: Si1029X-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFETs
- · Very Small Footprint
- · High-Side Switching
- Low On-Resistance: N-Channel, 1.40 Ω P-Channel, 4 Ω
- Low Threshold: ± 2 V (typ.)
- Fast Switching Speed: 15 ns (typ.)
- Gate-Source ESD Protected: 2000 V
- Compliant to RoHS Directive 2002/95/EC

BENEFITS

Marking Code: H

- · Ease in Driving Switches
- Low Offset (Error) Voltage
- Low-Voltage Operation
- · High-Speed Circuits

APPLICATIONS

- · Replace Digital Transistor, Level-Shifter
- · Battery Operated Systems
- Power Supply Converter Circuits

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)							
			N-Channel		P-Channel		
Parameter		Symbol	5 s	Steady State	5 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	60		- 60		V
Gate-Source Voltage		V_{GS}	± 20			v	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	I _D	320	305	- 200	- 190	
	T _A = 85 °C		230	220	- 145	- 135	
Pulsed Drain Current ^b		I _{DM}	650		- 650		mA
Continuous Source Current (Diode Conduction) ^a		I _S	450	380	- 450	- 380	
	T _A = 25 °C	P _D	280	250	280	250	mW
Maximum Power Dissipation ^a	T _A = 85 °C		145	130	145	130	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150				°C
Gate-Source ESD Rating (HBM, Method 3015)		ESD	2000				V

Notes

- a. Surface mounted on FR4 board.
- b. Pulse width limited by maximum junction temperature.

Pb-free

COMPLIANT HALOGEN FREE

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SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)								
Parameter	Symbol			Min.	Тур.	Max.	Unit	
Static					•	•		
Drain Course Breakdown Voltage	V	$V_{GS} = 0 \text{ V, } I_D = 10 \mu\text{A}$	N-Ch	60				
Drain-Source Breakdown Voltage	V_{DS}	V _{GS} = 0 V, I _D = - 10 μA	P-Ch	- 60			v	
Cata Threshold Voltage	Vaam	$V_{DS} = V_{GS}, I_D = 250 \mu A$	N-Ch	1		2.5		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = - 250 μA	P-Ch	- 1		- 3.0		
	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{CS} = \pm 5 \text{ V}$	N-Ch			± 50	nA	
Gate-Body Leakage			P-Ch			± 100		
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 10 \text{ V}$	N-Ch			± 150		
			P-Ch			± 200		
		$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch			10		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -50 \text{ V}, V_{GS} = 0 \text{ V}$	P-Ch			- 25		
Zero date voltage Brain ourrent	1088	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$	N-Ch			100		
		$V_{DS} = -50 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$	P-Ch			- 250		
		$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}$	N-Ch	500			mA	
On State Drain Currenta	ln()	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}$	P-Ch	- 50				
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = 7.5 \text{ V}, V_{GS} = -4.5 \text{ V}$	N-Ch	800				
		$V_{DS} = -10 \text{ V}, V_{GS} = -10 \text{ V}$	P-Ch	- 600				
		$V_{GS} = 4.5 \text{ V}, I_D = 200 \text{ mA}$	N-Ch			3		
		$V_{GS} = -4.5 \text{ V}, I_D = -25 \text{ mA}$	P-Ch			8		
Drain-Source On-State	R _{DS(on)}	$V_{GS} = 10 \text{ V, I}_{D} = 500 \text{ mA}$	N-Ch			1.40	Ω	
Resistance ^a		V _{GS} = - 10 V, I _D = - 500 mA	P-Ch			4		
		$V_{GS} = 10 \text{ V}, I_D = 500 \text{ mA}, T_J = 125 ^{\circ}\text{C}$	N-Ch			2.50		
		$V_{GS} = -10 \text{ V}, I_D = -500 \text{ mA}, T_J = 125 ^{\circ}\text{C}$	P-Ch			6		
F	g _{fs}	$V_{DS} = 10 \text{ V, I}_{D} = 200 \text{ mA}$	N-Ch		200		ma	
Forward Transconductance ^a		V _{DS} = - 10 V, I _D = - 100 mA	P-Ch		100		- ms	
Diede Fernand Vellere 3	V _{SD}	I _S = 200 mA, V _{GS} = 0 V	N-Ch			1.4	V	
Diode Forward Voltage ^a	V SD	I _S = - 200 mA, V _{GS} = 0 V	P-Ch			- 1.4	V	
Dynamic ^b								
Total Gate Charge	Q_{g}		N-Ch		750			
	Сg	N-Channel $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 250 \text{ mA}$	P-Ch		1700		pC	
Gate-Source Charge	Q_{gs}	VDS = 10 V, VGS = 4.3 V, ID = 230 IIIA	N-Ch		75			
Gate Course Charge	-gs	P-Channel	P-Ch		260			
Gate-Drain Charge	Q _{qd}	$V_{DS} = -30 \text{ V}, V_{GS} = -15 \text{ V}, I_{D} = -500 \text{ mA}$	N-Ch		225			
	gu		P-Ch		460			
Input Capacitance	C _{iss}	N-Channel	N-Ch		30		- pF	
		$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	P-Ch		23			
Output Capacitance		ge r de	N-Ch		6			
Reverse Transfer Capacitance	C _{rss}	P-Channel	P-Ch		10			
		$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	N-Ch P-Ch		3 5	-		
		N-Channel				 		
Turn-On Time ^c	t _{ON}	$V_{DD} = 30 \text{ V}, R_L = 150 \Omega$	N-Ch		15			
		$I_D \cong 200 \text{ mA}, V_{GEN} = 10 \text{ V}, R_g = 10 \Omega$	P-Ch		20	1	ns	
	t _{OFF}	P-Channel	N-Ch		20			
Turn-Off Time ^c		V_{DD} = - 25 V, R _L = 150 Ω $I_D \cong$ - 165 mA, V_{GEN} = - 10 V, R _g = 10 Ω			35		1	
		D , GEN,			1	1		

Notes:

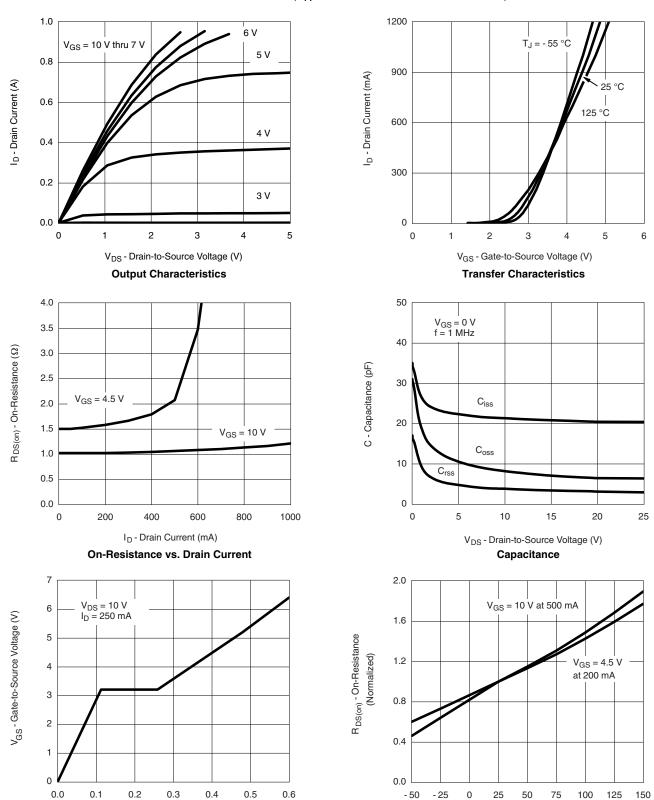
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.
- c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25 \, ^{\circ}C$, unless otherwise noted)



Q_a - Total Gate Charge (nC)

Gate Charge

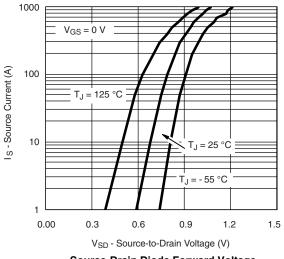
T_J - Junction Temperature (°C)

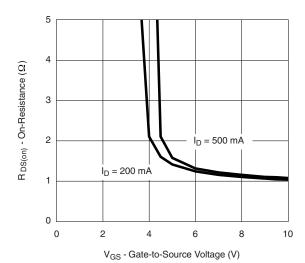
On-Resistance vs. Junction Temperature

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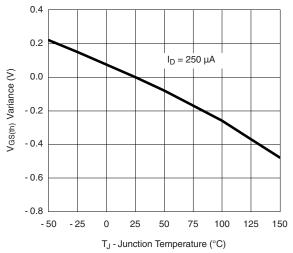
N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25~^{\circ}C$, unless otherwise noted)





Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

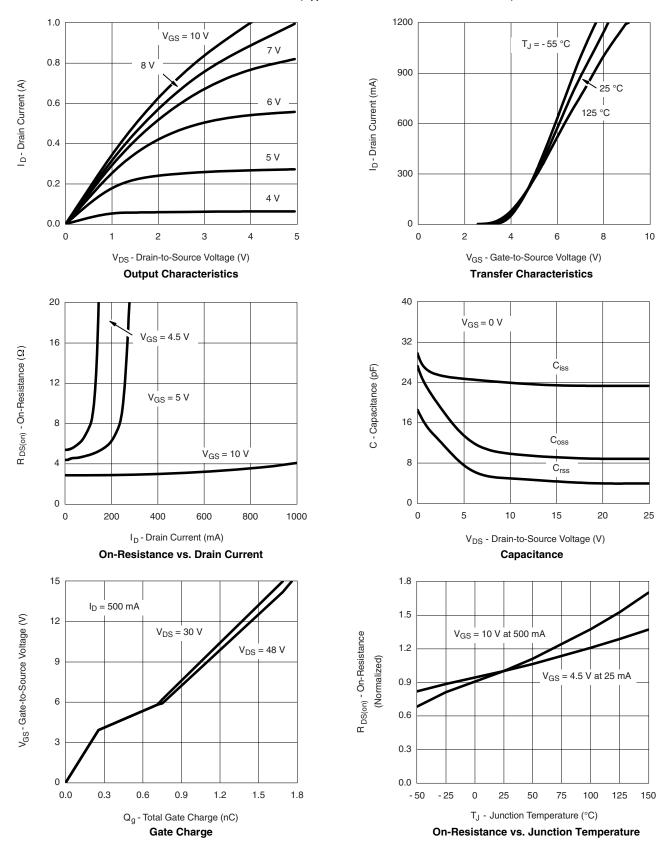


Threshold Voltage Variance Over Temperature





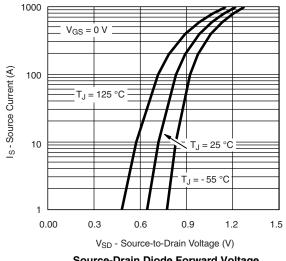
P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

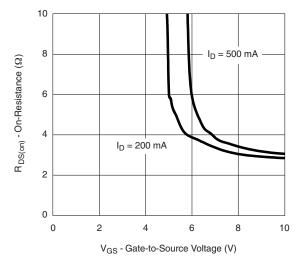


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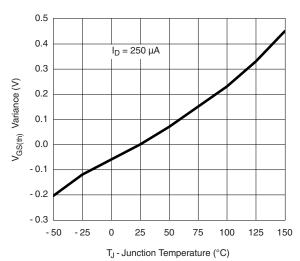
P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)





Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

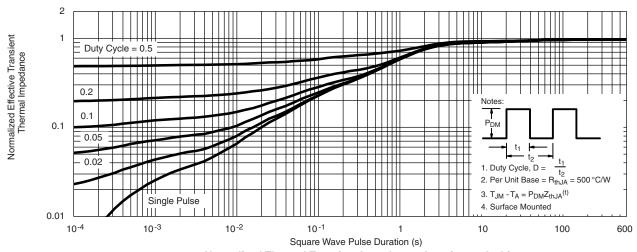


Threshold Voltage Variance Over Temperature





N- OR P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25~^{\circ}C$, unless otherwise noted)

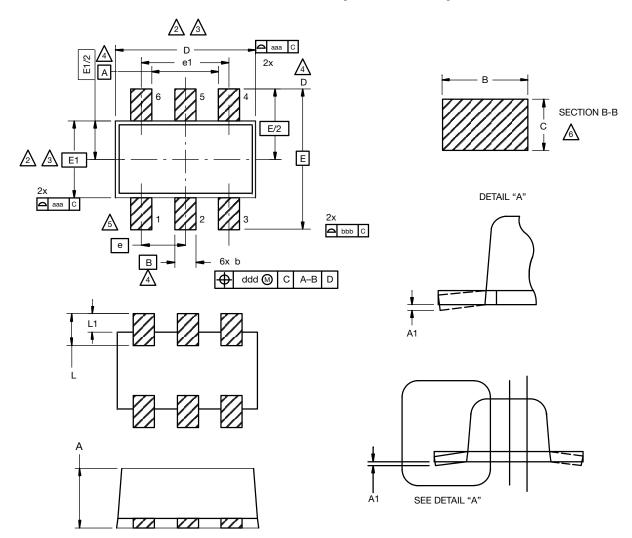


Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71435.



SC-89 6-Leads (SOT-563F)



Notes

1. Dimensions in millimeters.

Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.

Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.

ADatums A, B and D to be determined 0.10 mm from the lead tip.

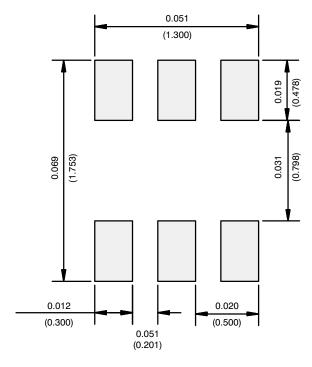
A Terminal numbers are shown for reference only.

These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

DIM.		MILLIMETERS			
	MIN.	NOM.	MAX.		
Α	0.56	0.58	0.60		
A1	0	0.02	0.10		
b	0.15	0.22	0.30		
С	0.10	0.14	0.18		
D	1.50	1.60	1.70		
E	1.50	1.60	1.70		
E1	1.15	1.20	1.25		
е	0.45	0.50	0.55		
e1	0.95	1.00	1.05		
L	0.25	0.35	0.50		
L1	0.10	0.20	0.30		
C14-0439-Rev. C, 11-Aug-14 DWG: 5880					



RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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